

Integrated Transceiver Modules for ZigBee / 802.15.4 (2.4 GHz) Development Kit Available

FEATURES

- 100mW output power
- Long range: 4000 feet
- Miniature footprint: 0.9" x 1.63"
- Integrated PCB F antenna or U.FL connector for external antenna
- Worldwide acceptance: FCC, IC and CE
- Powerful Texas Instruments 256k MSP430 with 802.15.4 MAC or ZigBee Stack
- LSR serial interface based on 802.15.4 MAC
- Low power operation
- RoHS compliant
- Streamlined development with LSR design services.
- License options available to purchase design or integrate design.

APPLICATIONS

- Security
- Lighting Control
- HVAC Control
- Sensor Networks
- Medical
- Smart Energy

ORDERING INFORMATION

DESCRIPTION

The ProFLEX01-R2 module is a high performance 2.4GHz IEEE 802.15.4 radio

(CC2520 & CC2591) and microcontroller (MSP430F5437A) in a cost effective, precertified footprint.



The module comes

preloaded with the TI MAC-Stack that can be used with the LSR host serial interface.

Full debug and programming capabilities are included to develop custom applications. Easily load the TI ZigBee stack or MAC onto the module and create your own network.

Need to get to market quickly? Not an expert in 802.15.4 or ZigBee? Need a custom antenna? Would you like to own the design? Would you like a custom design? Not quite sure what you need? Do you need help with your host board? LS Research Design Services will be happy to develop custom hardware or software, integrate the design, or license the design so you can manufacture yourself. Contact us at sales@lsr.com or call us at 262-375-4400.

Order Number	Description
450-0075	ProFLEX01-R2 Module with PCB F antenna (Tray) SPQ = 25
450-0076	ProFLEX01-R2 Module with U.FL connector for external antenna (Tray) SPQ = 250
450-0004	ProFLEX01-R2 Development Kit with F antenna

Table 1 Orderable ProFLEX01-R2 Model Numbers

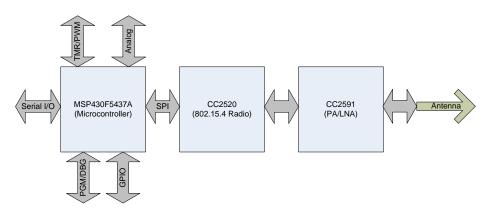


MODULE ACCESSORIES

Order Number	Description
001-0001	2.4 GHz Dipole Antenna with Reverse Polarity SMA Connector
080-0001	U.FL to Reverse Polarity SMA Bulkhead Cable 105mm



BLOCK DIAGRAM





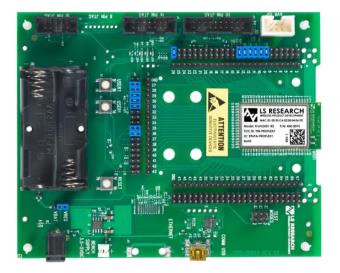
DEVELOPMENT KIT

The ProFLEX01-R2 Development Kit can be used out of the box to evaluate RF range performance with the simple press of a button.

Users interested in further investigating the performance and capabilities of the ProFLEX01-R2 Module can use the ProFLEX01-R2 Test Tool. This PC-based software can demonstrate just how easy it is to send & receive data, collect performance data, change channels, power levels, or addresses using the LSR Serial Host Protocol with another microcontroller.

More advanced users can use the development board to create and debug their own software for the ProFLEX01-R2 module using the 802.15.4 MAC or ZigBee stack from TI.

Part Number	Description
450-0004	ProFLEX01-R2 Development Kit with F Antenna





Kit Contents

- ProFLEX01-R2 Development Board with ProFLEX01-R2 Series Transceiver Module with F antenna (x2)
- USB Cable (x2)
- AA Batteries (x4)
- Quick Start Guide



TABLE OF CONTENTS

FEATURES
APPLICATIONS
DESCRIPTION
ORDERING INFORMATION
MODULE ACCESSORIES
BLOCK DIAGRAM
DEVELOPMENT KIT
MODULE PINOUT AND PIN DESCRIPTIONS
MODULE OVERVIEW11Microcontroller11Radio12PA/LNA14Antenna Options14
MODES OF OPERATION 16 Host Microcontroller 16 Software Stacks 17
DEVELOPMENT TOOLS 18 TI MSP-FET430UIF 18 IAR Embedded Workbench for MSP430 18
ELECTRICAL SPECIFICATIONS 19 Absolute Maximum Ratings 19 Recommended Operating Conditions 19 General Characteristics 20
RF Characteristics
RF Characteristics 21 SOLDERING RECOMMENDATIONS 24



REWORK	
SHIPPING, HANDLING, AND STORAGE	
Shipping	25
Handling	25
Moisture Sensitivity Level (MSL)	25
Storage	25
Repeating Reflow Soldering	
AGENCY STATEMENTS	
Agency Certifications	27
Federal Communication Commission Interference Statement	27
Industry Canada Statements	
OEM Responsibilities to comply with FCC and Industry Canada Regulations	29
End Product Labeling	
EUROPE	
CE Notice	
Declaration of Conformity (DOC)	
ANTENNA INFORMATION	
Dipole Antenna 001-0001	
F Antenna	
MECHANICAL DATA	
PCB Footprint	
General Module Dimensions	
COMPATIBILITY	
MODULE REVISION HISTORY	
Rev 1	
CONTACTING LS RESEARCH	



MODULE PINOUT AND PIN DESCRIPTIONS

GND 2 GND 3 - <	MCU#	GND	1																		69	GND		MCU#	
NC 4 86 NC NC 6 66 NC NC 7 61 NC NC 8 61 P5.6 56 73 JTAG TDI 10 60 P5.7 57 74 JTAG TDI 10 60 P5.7 57 75 JTAG TDI 12 89 P3.6 41 72 JTAG TDI 12 58 P5.5 55 71 TEST 13 Texas Instruments 57 P3.7 42 9 P5.0 15 55 P2.4 29 10 P5.1 16 55 P2.4 29 10 P5.1 16 54 P2.3 28 77 P6.0 17 53 P2.2 27 78 P6.1 18 50 P1.1 18 1 P6.4 21 40 P1.0 17 2 P6.5 22 47 P1.2 19 4 P6.7 24 49 90 51 P2.0 25	-	GND	2																		68	GND		-	
- NC 5 - NC 6 - NC 6 - NC 7 - NC 6 - NC 7 - NC 6 - NC 6 - NC 6 74 JTAG TDI 0 75 JTAG TCK 11 76 NC 6 7 77 JTAG TDO 12 76 NRESET 14 MSP430F5437A 56 P5.4 59 P3.6 41 9 P5.1 6 9 P5.1 6 9 P5.1 6 9 P6.1 18 1 P6.4 21 9 P6.5 22 9 P6.5 22 9 P6.6 23 4 P6.7 3 9 P6.4 24 9 P6.5 22 9 9<	-	GND	3		67 GND													-							
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	-	NC	4														-								
- NC 7 63 NC - - NC 8 63 NC - 74 JTAG TMS 9 61 P5.6 56 73 JTAG TD 10 61 P5.6 56 75 JTAG TD 12 58 P3.6 41 72 JTAG TD 12 58 P5.5 55 71 TEST 13 Texas Instruments 57 P3.7 42 76 nRESET 14 MSP430F5437A 56 P5.4 54 9 P5.0 15 55 P2.4 29 10 P5.1 16 55 P2.4 29 11 P6.4 21 55 P2.1 26 12 P6.5 22 50 P1.1 18	-	NC	5		65 NC												-								
- NC 8 9 - 9 92, NC - 74 JTAG TDI 10 - 61 P5.6 56 73 JTAG TDI 10 - 60 P5.7 57 75 JTAG TDO 12 - 59 P3.6 41 72 JTAG TDO 12 - 59 P3.7 50 76 nRESET 14 MSP430F5437A 56 P5.4 59 9 P5.0 15 - 55 P2.4 29 10 P5.1 16 - 53 P2.2 27 78 P6.1 18 - 53 P2.2 27 78 P6.1 18 - 50 P1.1 18 1 P6.6 22 - 40 P1.0 17 2 P6.6 22 - 40 P1.0 18 4 P6.7 24 44 P6.7 45 P8.1 61 4 P6.7	-	NC	6		64 NC												-								
74 JTAG TMS 9 61 P5.6 56 73 JTAG TDI 10 60 P5.7 57 75 JTAG TDO 12 58 P5.5 55 71 TEST 13 Texas Instruments 57 P3.7 42 76 nRESET 14 MSP430F5437A 56 P5.4 54 9 P5.0 15 55 52 22.1 28 78 P6.0 17 52 P2.1 26 79 P6.2 19 50 P1.1 18 71 P6.4 21 50 P1.1 18 79 P6.2 19 50 P1.1 18 71 P6.6 20 50 P1.1 18 71 P6.6 22 46 P8.0 60 74 P6.6 22 46 P8.0 60 74 P6.6 23 47 P1.2 19 74 P6.6 23 25 26 <t< td=""><td>-</td><td>NC</td><td>7</td><td></td><td colspan="12"></td><td>-</td><td></td></t<>	-	NC	7														-								
73 JTAG TDI 10 60 P5.7 57 75 JTAG TOK 11 59 P3.6 41 72 JTAG TDO 12 58 P5.5 55 71 TEST 13 Texas Instruments 57 P3.7 42 9 P5.0 15 F5.4 54 94 91 91 95.4 54 92.3 28 70 P6.0 17 52 P2.1 26 51 P2.0 25 80 P6.3 20 51 P2.0 25 50 91.1 18 1 P6.4 21 50 P1.1 18 77 P1.2 19 4 P6.7 24 54 P2.0 25 50 P1.1 18 1 P6.4 21 49 P1.0 17 77 8 3 P6.6 23 47 P1.2 19 46 P8.0 60 5 P7.4 25 46 P6.7 74 74 <	-	NC	8															-							
75 JTAG TCK 11 72 JTAG TDO 12 JTAG TDO 12 TEST 13 59 P3.6 41 72 JTAG TDO 12 TEST 13 Texas Instruments 57 P3.7 42 76 nRESET 14 9 MSP430F5437A 56 P5.4 54 9 P5.0 15 55 P2.4 29 10 P5.1 16 54 P2.3 28 77 P6.0 17 53 P2.2 27 78 P6.1 18 55 P2.4 29 79 P6.2 19 55 P2.0 25 80 P6.3 20 50 P1.1 18 1 P6.4 21 44 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 61 5 P7.4 25 7 7 7 8 3 P6.6 23 1 12 12 14 9 4 P6.7 24 45<	74	JTAG TMS	9		60 P5.7													56							
72 JTAG TDO 12 58 P5.5 55 71 TEST 13 Texas Instruments 57 P3.7 42 76 nRESET 14 MSP430F5437A 56 P5.4 54 9 P5.0 15 55 P2.4 29 10 P5.1 16 54 P2.3 28 77 P6.0 17 52 P2.1 26 79 P6.2 19 51 P2.0 25 80 P6.3 20 50 P1.1 18 1 P6.4 21 50 P1.1 18 1 P6.4 21 46 P8.0 60 5 P7.4 25 46 P8.0 60 5 P7.4 25 46 P8.0 60 5 P7.4 25 46 P6.7 46 P8.0 4 P6.7 24 46 P6.7 46 P8.0 60 5 P7.4 25 74	73	JTAG TDI	10															57							
71 TEST 13 Texas Instruments 57 P3.7 42 76 nRESET 14 MSP430F5437A 56 P5.4 54 9 P5.0 15 56 P2.4 29 10 P5.1 16 57 P2.3 28 77 P6.0 17 53 P2.2 27 78 P6.1 18 56 P1.1 18 79 P6.2 19 55 P2.0 25 80 P6.3 20 56 P1.1 18 1 P6.4 21 56 P1.1 18 1 P6.4 21 44 P1.0 17 2 P6.5 22 44 P1.0 17 3 P6.6 23 44 P1.0 17 44 P6.7 24 46 P8.0 60 5 P7.4 25 45 7 7 8 6 P7.4 25 45 7 7 7 <td>75</td> <td>JTAG TCK</td> <td>11</td> <td></td> <td></td> <td>41</td> <td></td>	75	JTAG TCK	11															41							
76 nRESET 14 MSP430F5437A 56 P5.4 54 9 P5.0 15 55 P2.4 29 10 P5.1 16 55 P2.4 29 77 P6.0 17 53 P2.2 27 78 P6.1 18 52 P2.1 26 90 P6.2 19 50 P1.1 18 1 P6.4 21 50 P1.1 18 1 P6.4 21 48 P7.7 8 3 P6.6 23 46 P8.0 60 5 P7.4 25 48 P7.7 8 4 P6.7 24 46 P8.0 60 5 P7.4 25 44 GND 61 4 P6.7 24 47 P1.2 19 4 P6.7 24 47 P1.2 19 4 P7.4 25 7 7 7 7 7 8 9	72		12																		58			55	
9 P5.0 15 10 P5.1 16 77 P6.0 17 78 P6.1 18 79 P6.2 19 80 P6.3 20 71 P6.4 21 72 P6.5 22 73 P6.6 23 80 P6.3 20 9 P6.5 22 80 P6.5 22 9 P6.6 23 9 P6.7 24 9 P7.4 25 9 <t< td=""><td>71</td><td>TEST</td><td>13</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>57</td><td>P3.7</td><td></td><td>42</td><td></td></t<>	71	TEST	13																		57	P3.7		42	
10 P5.1 16 54 P2.3 28 77 P6.0 17 53 P2.2 27 78 P6.1 18 52 P2.1 26 79 P6.2 19 51 P2.0 25 80 P6.3 20 50 P1.1 18 1 P6.4 21 49 P1.0 17 2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 44 GND 61 - VCC - 3V3DC 26 44 GND - 18 9 <t< td=""><td>76</td><td>nRESET</td><td>14</td><td></td><td></td><td></td><td></td><td></td><td>I</td><td>MS</td><td>P43</td><td>30F</td><td>543</td><td>37 A</td><td>•</td><td></td><td></td><td></td><td></td><td></td><td>56</td><td>P5.4</td><td></td><td>54</td><td></td></t<>	76	nRESET	14						I	MS	P43	30F	543	37 A	•						56	P5.4		54	
77 P6.0 17 53 P2.2 27 78 P6.1 18 52 P2.1 26 79 P6.2 19 51 P2.0 25 80 P6.3 20 50 P1.1 18 1 P6.4 21 49 P1.0 17 2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 46 P8.1 61 - VCC - 3V3DC 26 44 GND - 4 P6.7 24 44 A4 A4 </td <td>9</td> <td></td> <td>15</td> <td></td> <td>55</td> <td></td> <td></td> <td>29</td> <td></td>	9		15																		55			29	
78 P6.1 18 52 P2.1 26 79 P6.2 19 51 P2.0 25 80 P6.3 20 50 P1.1 18 1 P6.4 21 49 P1.0 17 2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 45 P8.1 61 - VCC - 3V3DC 26 26 44 GND - 44 GND 26 44 GND - - - VCC - 3V3DC 26 26 44 GND - - - - - - - - - - - - - - - - - - - - - - - - - - - - - -	10		16																		54	P2.3		28	
79 P6.2 19 51 P2.0 25 80 P6.3 20 50 P1.1 18 1 P6.4 21 49 P1.0 17 2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 46 P8.1 61 4 P6.7 24 46 P8.1 61 5 P7.4 25 45 P8.1 61 4 CND 46 P8.0 61 61 5 P7.4 25 45 P8.1 61 4 CND 46 P8.0 61 61 5 P7.4 25 50 7 7 7 7 4 CND 50 7 7 7 7 7 7 7 7 7 5 P7.4 25 5 <t< td=""><td>77</td><td></td><td>17</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>53</td><td></td><td></td><td>27</td><td></td></t<>	77		17																		53			27	
80 P6.3 20 50 P1.1 18 1 P6.4 21 49 P1.0 17 2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 45 P8.1 61 4 GND 7 24 44 GND 7 4 P0.7 24 7 25 44 GND 60 5 P7.4 25 44 GND 61 61 61 61 7 YCC - 3V3DC 26 YCC + 3V 3DC 26 YCC + 3V 3DC 26 YCC + 3V 3DC 7 7 7 8 9	78	P6.1	18																		52	P2.1		26	
1 P6.4 21 49 P1.0 17 2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 46 P8.0 61 - VCC - 3V3DC 26 44 GND 61 - - - - - - - - VCC - 3V3DC 26 - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - <t< td=""><td>79</td><td></td><td>19</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>51</td><td></td><td></td><td>25</td><td></td></t<>	79		19																		51			25	
2 P6.5 22 48 P7.7 8 3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 45 P8.1 61 - VCC - 3V3DC 26 44 GND - * 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 -	80		20																		50			18	
3 P6.6 23 47 P1.2 19 4 P6.7 24 46 P8.0 60 5 P7.4 25 45 P8.1 61 4 GND 44 GND 60 60 5 P7.4 25 45 P8.1 61 4 GND 44 GND 60 60 5 P7.4 25 44 GND 61 4 GND 5 7 </td <td>1</td> <td></td> <td>21</td> <td></td> <td>49</td> <td>P1.0</td> <td></td> <td>17</td> <td></td>	1		21																		49	P1.0		17	
4 P6.7 24 46 P8.0 60 5 P7.4 25 45 P8.1 61 - VCC - 3V3DC 26 44 GND - 44 GND - - - - 5 P7.4 25 26 - - - 44 GND - - - - - - - VCC - 3V3DC 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 - - -	2		22																		48			8	
5 P7.4 25 45 P8.1 61 - VCC - 3V3DC 26 44 GND - 1 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 - <td< td=""><td>3</td><td></td><td>23</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>47</td><td></td><td></td><td>19</td><td></td></td<>	3		23																		47			19	
- VCC - 3V3DC 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 - 9 9 7 7 8 2 9 30 31 0 7 7 8 0 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9	4	P6.7	24																		46	P8.0		60	
517 24 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 217 24 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 217 24 24 26 27 27 24 27 27 26 26 26 26 26 26 26 26 26 26 26 26 26																					45			61	
P4.7 P4.6 P4.6 P4.4 P4.1 P4.1 P4.1 P4.1 P4.1 P3.5/UART TX P3.5/UART TX P3.5/UART TX P3.5/UART TX P3.5/UART TX P3.5/UART TX P3.5/UART RX P3.5/UART RX	-	VCC - 3V3DC	26								1								1		44	GND		-	
P3.4/UAR P3.5/UAR P7.2/												35	36	37											
P3.4/UAR P3.5/UAR P7.2/				4.7	4.6	4.5	4.4	4.3	4.2	4.1	4.0	Ϋ́	КX	TS	7.3	8.6	8.5	8.4	8.3	8.2					
P3.5/				٩	٩	ፈ	ሲ	ፈ	٩	ፈ	ፈ	RT	RT	2/C	ሲ	ሲ	ፈ	ፈ	ፈ	۵.					
_												Ŋ	NAI	Ρ7.											
_												3.4/	3.5/												
MCU# 53 52 48 47 46 45 44 43 39 40 58 59 66 65 64 63 62 MCU#																~~	~-								
Figure 3 Module Pinout	MCU#			53	52	48	47	46								66	65	64	63	62				MCU#	

Figure 3 Module Pinout



Module Pin	Name	MCU Pin	Туре	Description
1	GND	N/A	GND	Ground
2	GND	N/A	GND	Ground
3	GND	N/A	GND	Ground
4	NC	N/A	NC	No Connect
5	NC	N/A	NC	No Connect
6	NC	N/A	NC	No Connect
7	NC	N/A	NC	No Connect
8	NC	N/A	NC	No Connect
9	JTAG TMS	74	I/O	General-purpose digital I/O Test mode select
10	JTAG TDI	73	I/O	General-purpose digital I/O Test data input or test clock input
11	JTAG TCK	75	I/O	General-purpose digital I/O Test clock
12	JTAG TDO	72	I/O	General-purpose digital I/O Test data output port
13	TEST	71	I	Test mode pin – select digital I/O on JTAG pins Spy-bi-wire input clock
14	nRESET	76	I/O	Reset input active low Non-maskable interrupt input Spy-bi-wire data input/output
15	P5.0	9	I/O	General-purpose digital I/O Output of reference voltage to the ADC Input for an external reference voltage to the ADC
16	P5.1	10	I/O	General-purpose digital I/O Negative terminal for the ADC's reference voltage for both sources, the internal reference voltage, or an external applied reference voltage
17	P6.0	77	I/O	General-purpose digital I/O Analog input
18	P6.1	78	I/O	General-purpose digital I/O Analog input
19	P6.2	79	I/O	General-purpose digital I/O Analog input
20	P6.3	80	I/O	General-purpose digital I/O Analog input
21	P6.4	1	I/O	General-purpose digital I/O Analog input
22	P6.5	2	I/O	General-purpose digital I/O Analog input



ProFLEX01-R2 TRANSCEIVER MODULE DATASHEET

Module Pin	Name	MCU Pin	Туре	Description
23	P6.6	3	I/O	General-purpose digital I/O Analog input
24	P6.7	4	I/O	General-purpose digital I/O Analog input
25	P7.4	5	I/O	General-purpose digital I/O Analog input
26	VCC - 3V3DC	VCC	VCC	Supply Voltage
27	P4.7	53	I/O	General-purpose digital I/O Timer_B7 clock input SMCLK output
28	P4.6	52	I/O	General-purpose digital I/O Timer_B7 capture CCR6: CCI6A/CCI6B input, compare: Out6 output
29	P4.5	48	I/O	General-purpose digital I/O Timer_B7 capture CCR5: CCI5A/CCI5B input, compare: Out5 output
30) P4.4 4		I/O	General-purpose digital I/O Timer_B7 capture CCR4: CCI4A/CCI4B input, compare: Out4 output
31	P4.3	46	I/O	General-purpose digital I/O Timer_B7 capture CCR3: CCI3A/CCI3B input, compare: Out3 output
32	P4.2 4		I/O	General-purpose digital I/O Timer_B7 capture CCR2: CCI2A/CCI2B input, compare: Out2 output
33	P4.1	44	I/O	General-purpose digital I/O Timer_B7 capture CCR1: CCI1A/CCI1B input, compare: Out1 output
34	P4.0	43	I/O	General-purpose digital I/O Timer_B7 capture CCR0: CCI0A/CCI0B input, compare: Out0 output
35	P3.4/UART TX	39	I/O	General-purpose digital I/O Transmit data – USCI_A0 UART mode Slave in, master out – USCI_A0 SPI mode
36	P3.5/UART RX	40	I/O	General-purpose digital I/O Receive data – USCI_A0 UART mode Slave out, master in – USCI_A0 SPI mode
37	P7.2	58	I/O	General-purpose digital I/O Switch all PWM outputs high impedance – Timer_B SVM output
38	P7.3	59	I/O	General-purpose digital I/O Timer1_A3 CCR2 capture: CCI2B input, compare: Out2 output



ProFLEX01-R2 TRANSCEIVER MODULE DATASHEET

Module Pin	Name	MCU Pin	Туре	Description
39	P8.6	66	I/O	General-purpose digital I/O Timer1_A3 CCR1 capture: CCI1B input, compare: Out1 output
40	P8.5	65	I/O	General-purpose digital I/O Timer1_A3 CCR0 capture: CCI0B input, compare: Out0 output
41	P8.4	64	I/O	General-purpose digital I/O Timer0_A5 CCR4 capture: CCI4B input, compare: Out4 output
42	P8.3	63	I/O	General-purpose digital I/O Timer0_A5 CCR3 capture: CCI3B input, compare: Out3 output
43	P8.2	62	I/O	General-purpose digital I/O Timer0_A5 CCR2 capture: CCI2B input, compare: Out2 output
44	GND	N/A	GND	Ground
45	P8.1	61	I/O	General-purpose digital I/O Timer0_A5 CCR1 capture: CCI1B input, compare: Out1 output
46	P8.0	60	I/O	General-purpose digital I/O Timer0_A5 CCR0 capture: CCI0B input, compare: Out0 output
47	P1.2	19	I/O	General-purpose digital I/O with port interrupt TA0 CCR1 capture: CCI1A input, compare: Out1 output BSL receive input
48	P7.7	8	I/O	General-purpose digital I/O Analog input
49	P1.0	17	I/O	General-purpose digital I/O with port interrupt Timer0_A5 clock signal TACLK input ACLK output
50	P1.1	18	I/O	General-purpose digital I/O with port interrupt Timer0_A5 CCR0 capture: CCI0A input, compare: Out0 output BSL transmit output
51	P2.0	25	I/O	General-purpose digital I/O with port interrupt Timer1_A3 clock signal TA1CLK input MCLK output
52	P2.1	26	I/O	General-purpose digital I/O with port interrupt Timer1_A3 CCR0 capture: CCI0A input, compare: Out0 output
53	P2.2	27	I/O	General-purpose digital I/O with port interrupt Timer1_A3 CCR1 capture: CCI1A input, compare: Out1 output



ProFLEX01-R2 TRANSCEIVER MODULE DATASHEET

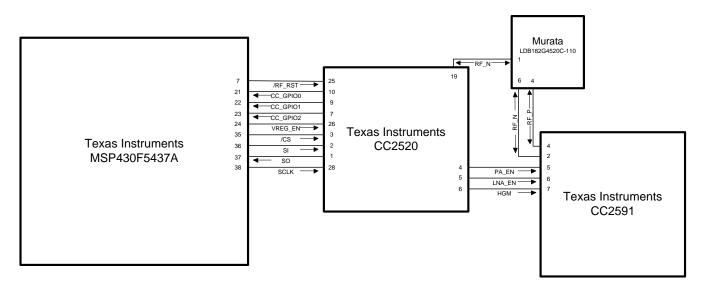
Module Pin	Name	MCU Pin	Туре	Description
54	P2.3	28	I/O	General-purpose digital I/O with port interrupt Timer1_A3 CCR2 capture: CCI2A input, compare: Out2 output
55	P2.4	29	I/O	General-purpose digital I/O with port interrupt RTCCLK output
56	P5.4	54	I/O	General-purpose digital I/O Slave out, master in – USCI_B1 SPI mode I2C clock – USCI_B1 I2C mode
57	P3.7	42	I/O	General-purpose digital I/O Slave in, master out – USCI_B1 SPI mode I2C data – USCI_B1 I2C mode
58	P5.5	55	I/O	General-purpose digital I/O Clock signal input – USCI_B1 SPI slave mode Clock signal output – USCI_B1 SPI master mode Slave transmit enable – USCI_A1 SPI mode
59	P3.6	41	I/O	General-purpose digital I/O Slave transmit enable – USCI_B1 SPI mode Clock signal input – USCI_A1 SPI slave mode Clock signal output – USCI_A1 SPI master mode
60	P5.7	57	I/O	General-purpose digital I/O Receive data – USCI_A1 UART mode Slave out, master in – USCI_A1 SPI mode
61	61 P5.6 56 I/		I/O	General-purpose digital I/O Transmit data – USCI_A1 UART mode Slave in, master out – USCI_A1 SPI mode
62	NC	N/A	NC	No Connect
63	NC	N/A	NC	No Connect
64	NC	N/A	NC	No Connect
65	NC	N/A	NC	No Connect
66	NC	N/A	NC	No Connect
67	GND	N/A	GND	Ground
68	GND	N/A	GND	Ground
69	GND	N/A	GND	Ground

Table 2 ProFLEX01-R2 Module Pin Descriptions



MODULE OVERVIEW

Figure 4 shows the internal interconnects of the ICs on the ProFLEX01-R2 module. Consult the respective IC datasheets for details, or contact LSR sales to purchase the ProFLEX01-R2 module schematics as part of LSR's ModFLEX[™] design program. For a high-level block diagram of the ProFLEX01-R2 module, see Figure 1.





Microcontroller

A member of the Texas Instruments MSP430 family of ultra-low-power microcontrollers, the architecture, combined with five low-power modes, is optimized to achieve extended battery life. The device features a powerful 16-bit RISC CPU, 16-bit registers, and constant generators that contribute to maximum code efficiency. The digitally controlled oscillator (DCO) allows wake-up from low-power modes to active mode in less than 5 µs. It can be configured to use up to three 16-bit timers, a high performance 12-bit analog-to-digital (A/D) converter, up to four universal serial communication interfaces (USCI), hardware multiplier, DMA, real time clock module with alarm capabilities, and up to 87 I/O pins. Figure 5 shows a block diagram of the MSP430F5437A.

The information in this document is subject to change without notice.



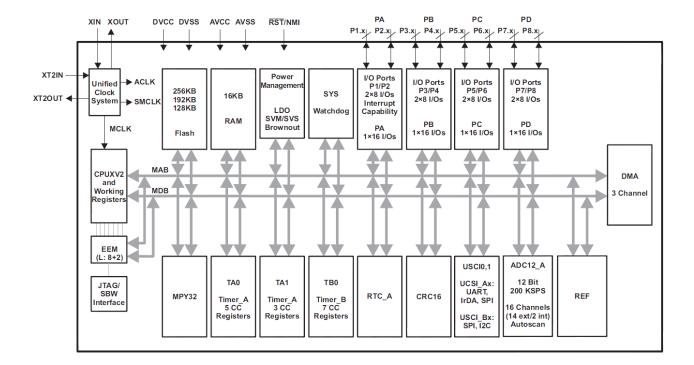


Figure 5 MSP430F5437A Block Diagram

Radio

The CC2520 is TI's second generation ZigBee / IEEE 802.15.4 RF transceiver for the 2.4 GHz unlicensed ISM band. This chip enables industrial grade applications by offering state-of-the-art selectivity/co-existence, excellent link budget, operation up to 125°C and low voltage operation. In addition, the C2520 provides extensive hardware support for frame handling, data buffering, burst transmissions, data encryption, data authentication, clear channel assessment, link quality indication and frame timing information. These features reduce the load on the host controller. Figure 6 shows a block diagram of the CC2520.

The information in this document is subject to change without notice.



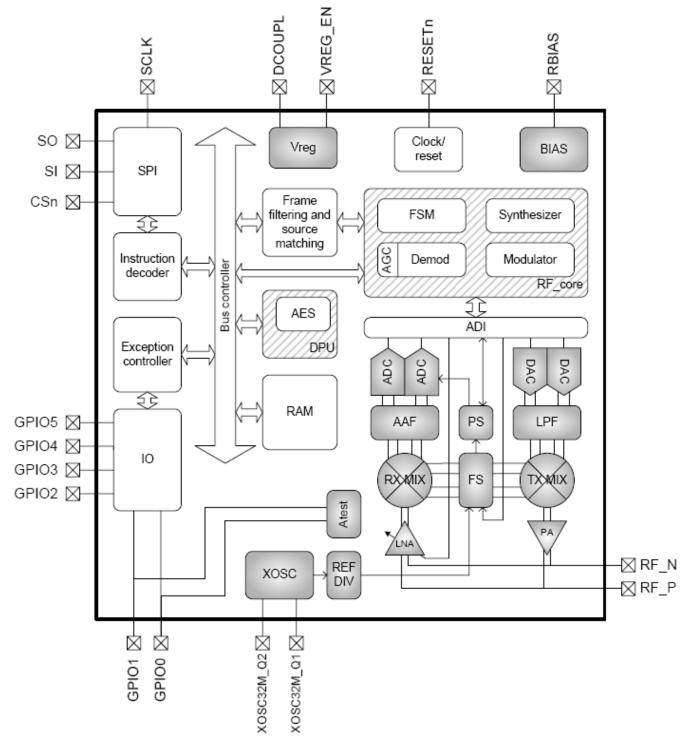


Figure 6 CC2520 Block Diagram



PA/LNA

The CC2591 is a cost-effective and high performance RF Front End for low-power and low-voltage 2.4-GHz wireless applications. It is a range extender for all existing and future 2.4-GHz low-power RF transceivers, transmitters and System-on-Chip products from Texas Instruments. It increases the link budget by providing a power amplifier for increased output power, and a LNA with low noise figure for improved receiver sensitivity. It provides a small size, high output power RF design with its 4x4-mm QFN-16 package. It contains PA, LNA, switches, RF-matching, and balun for simple design of high performance wireless applications. Figure 7 shows a block diagram of the CC2591.

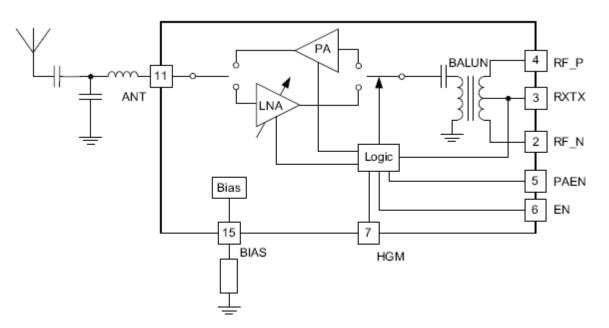


Figure 7 CC2591 Block Diagram

Antenna Options

The ProFLEX01-R2 module includes an integrated PCB F-antenna. An optional configuration with a U.FL connector is also available. The module regulatory certification has been completed with the following antennas:

- PCB trace antenna
- LSR 001-0001 2.4 GHz Dipole Antenna with Reverse Polarity SMA Connector and LSR 080-0001 U.FL to Reverse Polarity SMA Bulkhead Cable 105mm
- Nearson S131CL-6-PX-2450S dipole antenna on a 6 inch cable with connectors.

An adequate ground plane is necessary to provide good efficiency. The ground plane of the host board on which the module is mounted increases the effective antenna ground plane size and improves the antenna performance.

The environment the module is placed in will dictate the range performance. The non-ideal characteristics of the environment will result in the transmitted signal being reflected, diffracted, and scattered. All of these factors randomly combine to create extremely complex scenarios that will affect the link range in various ways.

The information in this document is subject to change without notice.



It is also best to keep some clearance between the antenna and nearby objects. This includes how the module is mounted in the product enclosure. Unless the items on the following list of recommendations are met, the radiation pattern can be heavily distorted.

Whichever antennas are used, it is best to keep a few things in mind when determining their location.

- Never place ground plane or copper trace routing underneath the antenna.
- LSR recommends keeping metal objects as far away from the antenna as possible. At a very minimum keep the antennas at least 16mm from any metallic objects, components, or wiring. The farther the antenna is placed from these interferers, the less the radiation pattern and gain will be perturbed
- Do not embed the antenna in a metallic or metalized plastic enclosure.
- Try to keep any plastic enclosure greater than 1 cm from the antenna in any orientation.

The information in this document is subject to change without notice.



MODES OF OPERATION

- With a host microcontroller
- With the TI 802.15.4 MAC, ZigBee stack, RF4CE stack, and SimpliciTI

Host Microcontroller

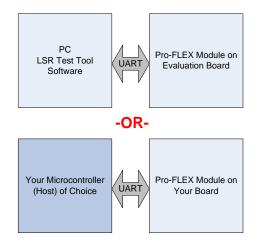


Figure 8 Host Microcontroller Modes of Operation

Out of the box the ProFLEX01-R2 module contains an 802.15.4 based application that uses a host serial processor. This allows features of the module to be explored with the LSR PC based test tool, or controlled with a host microcontroller. The advantage of this method is simplicity; all major features of using the radio are simplified into a simple serial message, taking the burden of becoming a radio expert off the developer.

Use the Communications Log in the ModFLEX[™] Test Tool Suite software and serial host protocol documents to see the messages in action. It will help you become familiar with the serial commands and how to implement them on your own microcontroller.



Figure 9 ModFLEX™ Test Tool Communications Log

Some examples of serial commands that can be used with the ProFLEX01-R2 Module:

- Set/Query RF channel
- Set/Query RF power
- Set/Query device address
- Transmit RF data or notification RF data received
- Go to Sleep



Software Stacks

There are several software stacks provided by TI to streamline development, two of which are described below:

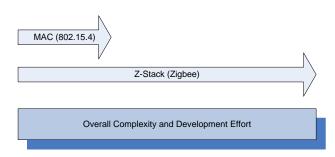


Figure 10 ProFLEX01-R2 Compatible Stacks

802.15.4 MAC

- Use for applications requiring point-to-point or star network topology.
- Advantages: Quick learning curve, minimize software development, easy to deploy in the field
- Disadvantages: No mesh networking

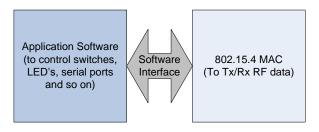


Figure 11 ProFLEX01-R2 with 802.15.4 MAC

TI Z-Stack (ZigBee)

- Use when mesh networking is required.
- Advantages: Covers a large area with a ZigBee network.
- Disadvantages: Large learning curve, more software development, and complexity

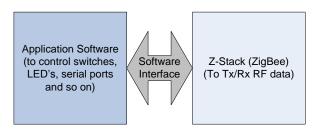


Figure 12 ProFLEX01-R2 with TI Z-Stack (ZigBee)



DEVELOPMENT TOOLS

TI MSP-FET430UIF

Custom firmware development can be done on the ProFLEX01-R2 module using development tools available thought TI. Shown in Figure 13, a MSP-FETUIF USB interface is required. It plugs directly into the ProFLEX01-R2 Development Board (see Figure 2), and can easily be adapted to other hardware. See the Texas Instruments website for more information.



Figure 13 MSP-FET430UIF

IAR Embedded Workbench for MSP430

Also required is Embedded Workbench for TI MSP430 from IAR Systems. IAR Embedded Workbench for MSP430 is an integrated development environment for building and debugging embedded applications. Visit the IAR Systems website for additional information.

The information in this document is subject to change without notice.



ELECTRICAL SPECIFICATIONS

The majority of these characteristics are based on the use of the TI 802.15.4 MAC loaded with the generic application firmware written by LSR. Custom firmware may require these values to be re-characterized by the customer.

Absolute Maximum Ratings

Parameter	Min	Мах	Unit
Power supply voltage (VCC)	-0.2	+3.6	V
Voltage on any GPIO	-0.2	VCC + 0.2	V
RF input power, antenna port		+10	dBm
RF input power, transmit port		+8	dBm
Operating temperature	-40	+85	٥C
Storage temperature	-40	+105	٥C

Table 3 Absolute Maximum Ratings¹

Recommended Operating Conditions

Parameter	Min	Тур	Мах	Unit
Power supply voltage (VCC)	2.0		3.3	Vdc
Input frequency	2405		2480	MHz
Ambient temperature range	-40	25	85	°C

 Table 4 Recommended Operating Conditions

Module will NOT transmit, if VCC > 3.4V.

¹ Under no circumstances should exceeding the ratings specified in the Absolute Maximum Ratings section be allowed. Stressing the module beyond these limits may result permanent damage to the module that is not covered by the warranty.



General Characteristics

Parameter	Min	Тур	Мах	Unit
RF frequency range	2405		2480	MHz
RF data rate		250		kbps
Host data rate	1.2	19.2	921.6	kbps
Flash memory		256		kB
RAM		16		kB
Flash information memory		512		Bytes

Table 5 General Characteristics

Power Consumption

Parameter	Test Conditions	Min	Тур	Мах	Unit
Transmit mode	2440 MHz, 3.3V, +25°C, +20 dBm	125	149	175	mA
Receive mode	2440 MHz, 3.3V, +25°C, -50 dBm input	25	30	35	mA
Sleep mode			3		uA

Table 6 Power Consumption

DC Characteristics – General Purpose I/O

Parameter	Test Conditions	Min	Тур	Мах	Unit
Logic input low		-0.2		20% VCC	V
Logic input high		80% VCC		VCC + 0.2	V
Logic output low (Full Drive)	lout = 5 mA	VSS		VSS + 0.25	V
	lout = 15 mA	VSS		VSS + 0.60	V
Logic output low	lout = 2 mA	VSS		VSS + 0.25	V
(Reduced Drive)	lout = 6 mA	VSS		VSS + 0.60	V
Logic output high	lout = -5 mA	VCC – 0.25		VCC	V
(Full Drive)	lout = -15 mA	VCC - 0.60		VCC	V
Logic output high	lout = -2 mA	VCC – 0.25		VCC	V
(Reduced Drive)	lout = -6 mA	VCC - 0.60		VCC	V

Table 7 DC Characteristics General Purpose I/O



RF Characteristics

Transmitter Characteristics (TA =25°C, VCC=3.3 V, fc =2440 MHz)

Parameter	Test Conditions	Min	Тур	Мах	Unit
Nominal output power	100mW	18	20	21	dBm
Programmable output power range		7		21	dB
Error vector magnitude			12	35	%

 Table 8 Transmitter RF Characteristics

LSR Host RF Power Value	CC2520 TXPOWER Register Value	Typical RF Output Power	Typical Current Consumption	
0				
1				
2				
3				
4	0×40	7	77 4	
5	0x49	7 dBm	77 mA	
6				
7				
8				
9				
10				
11	0x79	12 dBm	92 mA	
12				
13	0x6C	16 dBm	105 mA	
14	UXOC		TUS IIIA	
15	0xE0	18 dBm	122 mA	
16	UXEU		122 IIIA	
17				
18	0xF9	20 dBm	149 mA	
19				

Table 9 RF Power Settings with LSR Host Software



Tables 10-12 below list the nominal RF Power Limits per channel that must be maintained to assure compliance with FCC or ETSI.

RF Channel	Max LSR Host RF Power Value	CC2520 TXPOWER Register Value	RF Output Power
11	16	0xE0	18 dBm
12	16	0xE0	18 dBm
13	16	0xE0	18 dBm
14	19	0xF9	20 dBm
15	19	0xF9	20 dBm
16	19	0xF9	20 dBm
17	19	0xF9	20 dBm
18	19	0xF9	20 dBm
19	19	0xF9	20 dBm
20	19	0xF9	20 dBm
21	19	0xF9	20 dBm
22	19	0xF9	20 dBm
23	19	0xF9	20 dBm
24	19	0xF9	20 dBm
25	16	0xE0	18 dBm
26	Not used	Not used	Not used

Table 10 RF Transmit Output Power Limits for FCC Compliance (Internal or External Antenna)

RF Channel	Max LSR Host RF Power Value	CC2520 TXPOWER Register Value	RF Output Power
11	12	0x79	12 dBm
12	12	0x79	12 dBm
13	12	0x79	12 dBm
14	12	0x79	12 dBm
15	12	0x79	12 dBm
16	12	0x79	12 dBm
17	12	0x79	12 dBm
18	12	0x79	12 dBm
19	12	0x79	12 dBm
20	12	0x79	12 dBm
21	12	0x79	12 dBm
22	12	0x79	12 dBm
23	12	0x79	12 dBm
24	12	0x79	12 dBm
25	12	0x79	12 dBm
26	12	0x79	12 dBm

Table 11 RF Transmit Output Power Limits for ETSI Compliance (Internal Antenna)



RF Channel	Max LSR Host RF Power Value	CC2520 TXPOWER Register Value	RF Output Power
11	9	0x49	7 dBm
12	9	0x49	7 dBm
13	9	0x49	7 dBm
14	9	0x49	7 dBm
15	9	0x49	7 dBm
16	9	0x49	7 dBm
17	9	0x49	7 dBm
18	9	0x49	7 dBm
19	9	0x49	7 dBm
20	9	0x49	7 dBm
21	9	0x49	7 dBm
22	9	0x49	7 dBm
23	9	0x49	7 dBm
24	9	0x49	7 dBm
25	9	0x49	7 dBm
26	9	0x49	7 dBm

Table 12 RF Transmit Output Power Limits for ETSI Compliance (External Antenna)

Receiver Characteristics (TA =25°C, VCC=3.3 V, fc =2440 MHz)

Parameter	Test Conditions		Min	Тур	Мах	Unit
Receiver sensitivity (1% PER)	HGM		-95	-98	-99	dBm
Saturation (maximum input level) (1% PER)	HGM			-13		dBm
Interference rejection B02.15.4 Interferer		±5 MHz		51		dB
		±10 MHz		56		dB
	±20 MHz		57		dB	

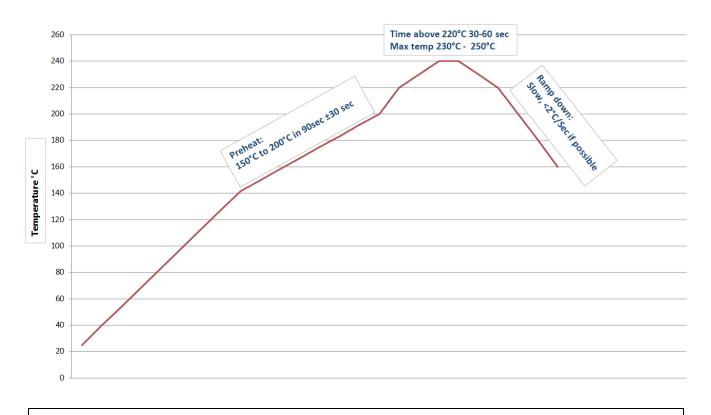
Table 13 Receiver RF Characteristics

For additional details regarding the electrical specifications, see the MSP430F5437A, CC2520, and CC2591 datasheets on the TI website.



SOLDERING RECOMMENDATIONS

Recommended Reflow Profile for Lead Free Solder



Note: The quality of solder joints on the castellations ('half vias') where they contact the host board should meet the appropriate IPC Specification. See IPC-A-610-D Acceptability of Electronic Assemblies, section 8.2.4 Castellated Terminations."

The information in this document is subject to change without notice.



CLEANING

In general, cleaning the populated modules is strongly discouraged. Residuals under the module cannot be easily removed with any cleaning process.

- Cleaning with water can lead to capillary effects where water is absorbed into the gap between the host board and the module. The combination of soldering flux residuals and encapsulated water could lead to short circuits between neighboring pads. Water could also damage any stickers or labels.
- Cleaning with alcohol or a similar organic solvent will likely flood soldering flux residuals into the RF shield, which is not accessible for post-washing inspection. The solvent could also damage any stickers or labels.
- Ultrasonic cleaning could damage the module permanently.

OPTICAL INSPECTION

After soldering the Module to the host board, consider optical inspection to check the following:

- Proper alignment and centering of the module over the pads.
- Proper solder joints on all pads.
- Excessive solder or contacts to neighboring pads, or vias.

REWORK

The module can be unsoldered from the host board if the Moisture Sensitivity Level (MSL) requirements are met as described in this datasheet.

Never attempt a rework on the module itself, e.g. replacing individual components. Such actions will terminate warranty coverage.

SHIPPING, HANDLING, AND STORAGE

Shipping

Bulk orders of the ProFLEX01-R2 modules are delivered in trays of 25.

Handling

The ProFLEX01-R2 modules contain a highly sensitive electronic circuitry. Handling without proper ESD protection may destroy or damage the module permanently. ESD protection may destroy or damage the module permanently.

Moisture Sensitivity Level (MSL)

Per J-STD-020, devices rated as MSL 4 and not stored in a sealed bag with desiccant pack should be baked prior to use.

After opening packaging, devices that will be subjected to reflow must be mounted within 72 hours of factory conditions (<30°C and 60% RH) or stored at <10% RH.

Bake devices for 48 hours at 125°C.

Storage

Please use this product within 6 months after receipt. Any product used after 6 months of receipt needs to have solderability confirmed before use.

The product shall be stored without opening the packing under the ambient temperature from 5 to 35deg.C and humidity from 20 to 70%RH. (Packing materials, in particular, may be deformed at the temperatures above this range.)

Do not store in salty air or in an environment with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NOX.

Do not store in direct sunlight.

The product should not be subject to excessive mechanical shock.

The information in this document is subject to change without notice.



Repeating Reflow Soldering

Only a single reflow soldering process is encouraged for host boards.

The information in this document is subject to change without notice.



AGENCY STATEMENTS

Agency Certifications

FCC ID: TFB-PROFLEX1

IC ID: 5969A-PROFLEX1

CE: Compliant to standards EN 60950-1, EN 300 328, and EN 301 489

Federal Communication Commission Interference Statement

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

<u>FCC CAUTION</u>: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

The information in this document is subject to change without notice.



Industry Canada Statements

Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that permitted for successful communication.

This device has been designed to operate with the antennas listed below, and having a maximum gain of 2.0 dB. Antennas not included in this list or having a gain greater than 2.0 dB are strictly prohibited for use with this device. The required antenna impedance is 50 ohms.

LS Research 001-0001 2.4 GHz Dipole Antenna with Reverse Polarity SMA Connector and LS Research 080-0001 U.FL to Reverse Polarity SMA Cable.

Nearson \$131CL-6-PX-2450\$

Embedded PCB trace antenna

The information in this document is subject to change without notice.



OEM Responsibilities to comply with FCC and Industry Canada Regulations

The ProFLEX01-R2 Module has been certified for integration into products only by OEM integrators under the following conditions:

This device is granted for use in Mobile only configurations in which the antennas used for this transmitter must be installed to provide a separation distance of at least 20cm from all person and not be co-located with any other transmitters except in accordance with FCC and Industry Canada multi-transmitter product procedures.

As long as the two conditions above are met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

IMPORTANT NOTE: In the event that these conditions cannot be met (for certain configurations or co-location with another transmitter), then the FCC and Industry Canada authorizations are no longer considered valid and the FCC ID and IC Certification Number cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC and Industry Canada authorization.

The information in this document is subject to change without notice.



End Product Labeling

The ProFLEX01-R2 Module is labeled with its own FCC ID and IC Certification Number. If the FCC ID and IC Certification Number are not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. In that case, the final end product must be labeled in a visible area with the following:

"Contains Transmitter Module FCC ID: TFB-PROFLEX1"

"Contains Transmitter Module IC: 5969A-PROFLEX1"

or

"Contains FCC ID: TFB-PROFLEX1"

"Contains IC: 5969A-PROFLEX1"

The OEM of the ProFLEX01-R2 Module must only use the approved antenna(s) listed above, which have been certified with this module.

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product.

The user manual for the end product must include the following information in a prominent location:

This device is granted for use in Mobile only configurations in which the antennas used for this transmitter must be installed to provide a separation distance of at least 20cm from all person and not be co-located with any other transmitters except in accordance with FCC and Industry Canada multi-transmitter product procedures.

The information in this document is subject to change without notice.



EUROPE

CE Notice

This device has been tested and certified for use in the European Union. See the Declaration of Conformity (DOC) for specifics.

If this device is used in a product, the OEM has responsibility to verify compliance of the final product to the EU standards. A Declaration of Conformity must be issued and kept on file as described in the Radio and Telecommunications Terminal Equipment (R&TTE) Directive.

The 'CE' mark must be placed on the OEM product per the labeling requirements of the Directive.

Declaration of Conformity (DOC)

This DOC can be downloaded from the LSR Wiki.

The information in this document is subject to change without notice.



ANTENNA INFORMATION

Dipole Antenna 001-0001

See antenna datasheet.

F Antenna

Flat 2.405 GHz

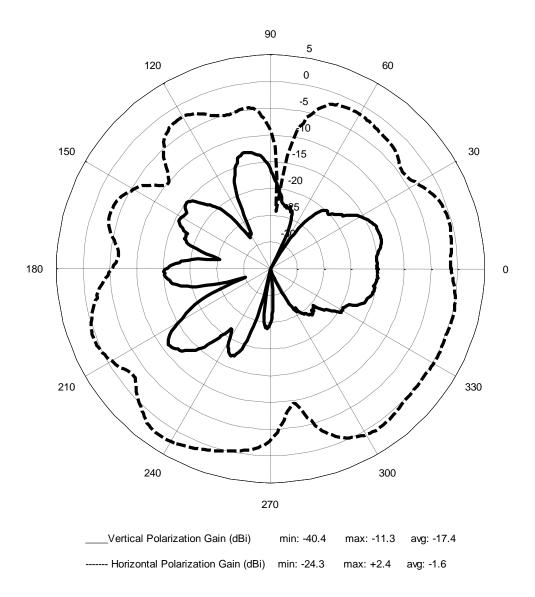


Figure 14 Flat 2.405 GHz



Flat 2.440 GHz

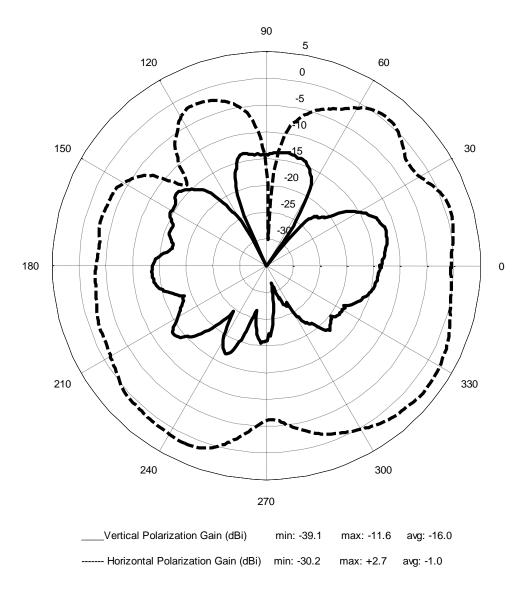


Figure 15 Flat 2.440 GHz



Flat 2.480 GHz

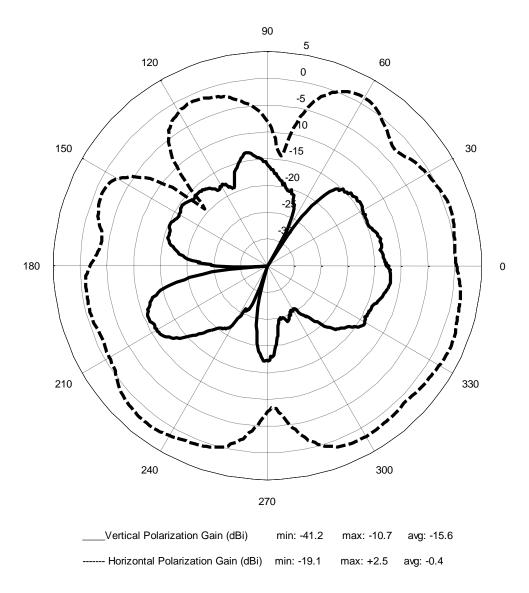


Figure 16 Flat 2.480 GHz



Side 2.405 GHz

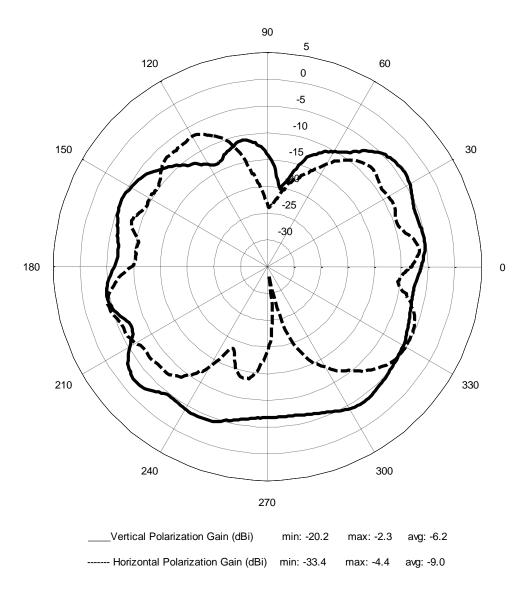


Figure 17 Side 2.405 GHz



Side 2.440 GHz

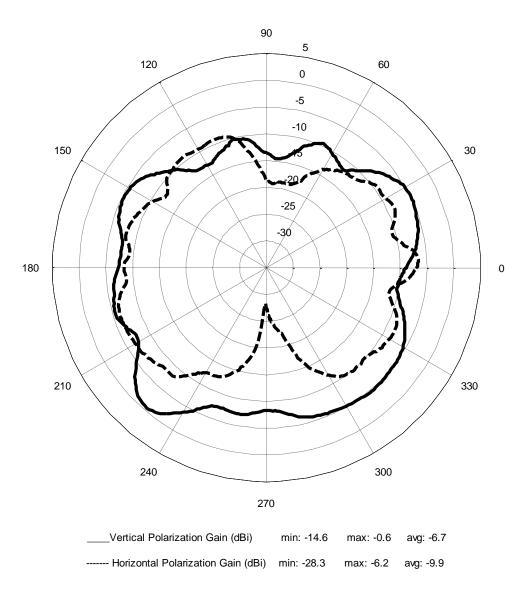


Figure 18 Side 2.440 GHz



Side 2.480 GHz

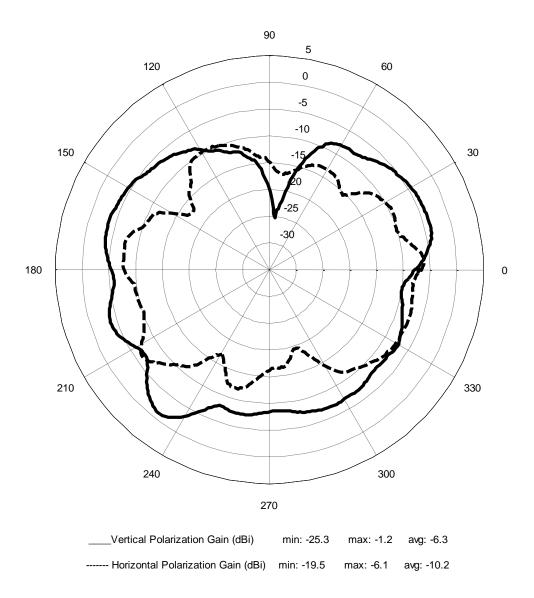


Figure 19 Side 2.480 GHz



Vertical 2.405 GHz

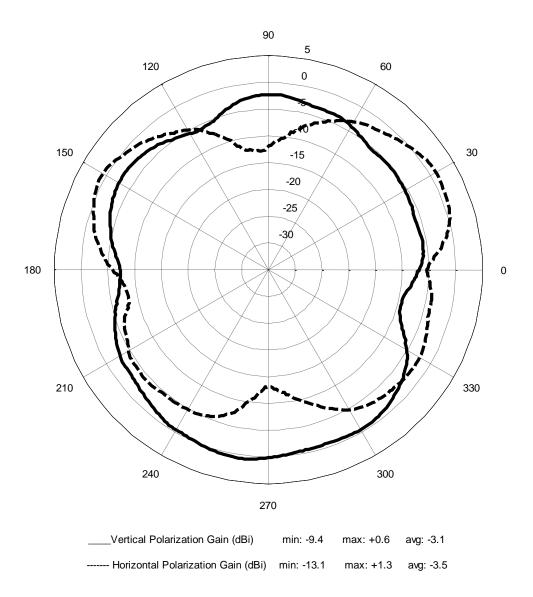


Figure 20 Vertical 2.405 GHz



Vertical 2.440 GHz

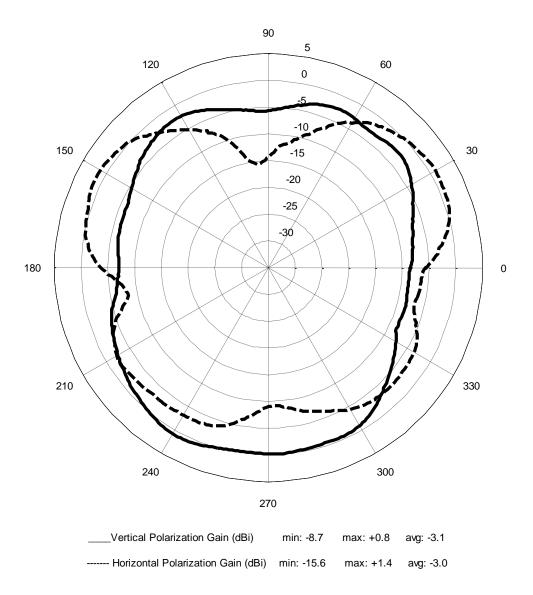


Figure 21 Vertical 2.440 GHz



Vertical 2.480 GHz

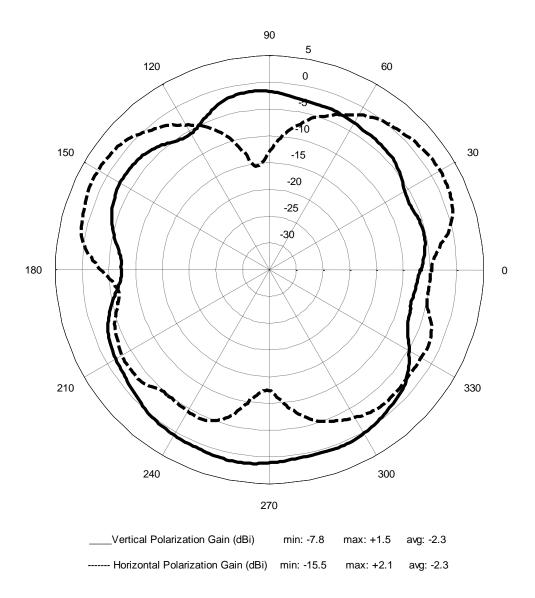
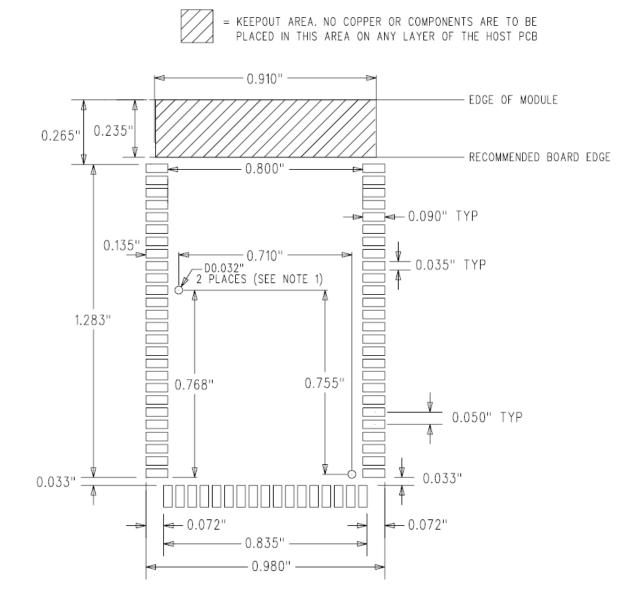


Figure 22 Vertical 2.480 GHz



MECHANICAL DATA

PCB Footprint



Notes:

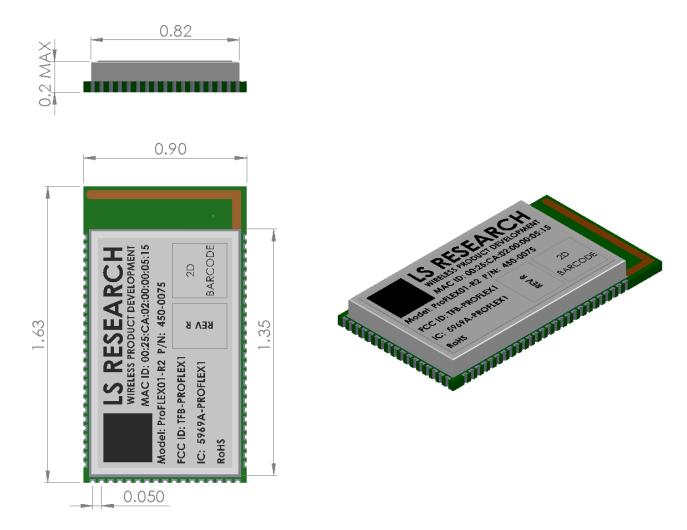
1) Optional alignment holes are for use with fixture placement and hand soldering operations.

2) See <u>http://wiki.lsr.com</u> for additional information.

Figure 23 PCB footprint



General Module Dimensions







COMPATIBILITY

To maintain compatibility with other ModFLEX[™] family transceiver modules it is important to use the module pins in your application as they are designated in Figure 25. Since the available GPIO and peripherals vary per micro, not all pins may be populated.

All attempts are made to lay out modules starting with the lowest number in the peripheral (ADC, TMR/PWM, GPIO) series. For example if there are only two ADC's available they will be brought out to ADC1 and ADC2 (module pins 20 and 21).

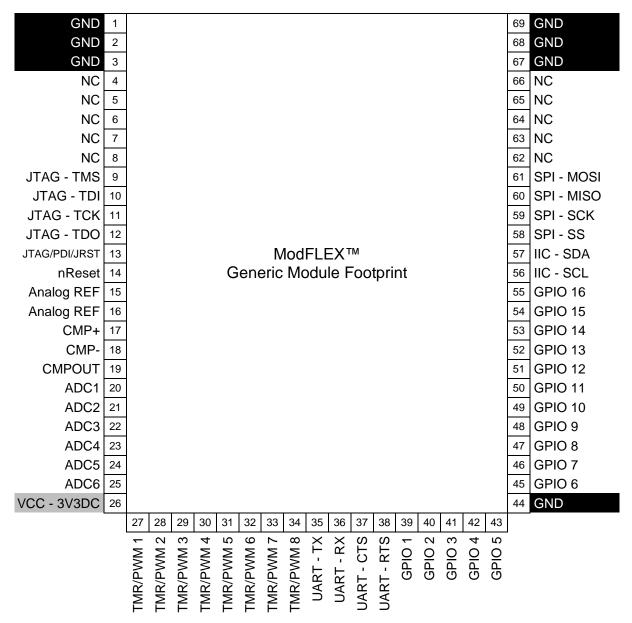


Figure 25 ModFLEX™ Generic Module Footprint



MODULE REVISION HISTORY

Rev 1

• Initial production release.

Part Number: 450-0075 F Antenna Module



00:25:CA:02:XX:XX:XX = MAC ID 2D Barcode Format is Data Matrix Standard XX:XX:XX:XX = unique portion of MAC ID that changes for each module Part Number: 450-0076 U.FL Module



00:25:CA:02:XX:XX:XX = MAC ID 2D Barcode Format is Data Matrix Standard XX:XX:XX:XX = unique portion of MAC ID that changes for each module

The information in this document is subject to change without notice.



CONTACTING LS RESEARCH

Headquarters	LS Research, LLC W66 N220 Commerce Court Cedarburg, WI 53012-2636 USA Tel: 1(262) 375-4400 Fax: 1(262) 375-4248
Website	www.lsr.com
Wiki	wiki.lsr.com
Technical Support	forum.lsr.com
Sales Contact	sales@lsr.com

The information in this document is provided in connection with LS Research (hereafter referred to as "LSR") products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of LSR products. EXCEPT AS SET FORTH IN LSR'S TERMS AND CONDITIONS OF SALE LOCATED ON LSR'S WEB SITE, LSR ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL LSR BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS OF PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF LSR HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. LSR makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and product descriptions at any time without notice. LSR does not make any commitment to update the information contained herein. Unless specifically provided otherwise, LSR products are not suitable for, and shall not be used in, automotive applications. LSR's products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

LS Research: <u>450-0075</u> <u>450-0076</u> <u>450-0004</u>